



PD3SD2580

SURFACE MOUNT FAST SWITCHING DIODE PowerDI® 323

Features

- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: PowerDI323
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Leads: Matte Tin Finish annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Marking Information: See Below
- Ordering Information: See Below
- Weight: 0.005 grams (approximate)

PowerDI323







BOTTOM VIEW

Ordering Information (Note 4)

Part Number	Case	Packaging
PD3SD2580-7	PowerDI323	3000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information



D1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)

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Year	2006	20	007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017
Code	Т	ī	U	V	W	Χ	Υ	Z	А	В	С	D	Е
Month	J	lan	Feb	b Ma	r Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code		1	2	3	4	5	6	7	8	9	0	N	D





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	80	V
RMS Reverse Voltage		V _{R(RMS)}	57	V
Forward Continuous Current		I _{FM}	250	mA
Repetitive Peak Forward Current		I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0ms @ t = 1.0s	I _{FSM}	3.3 0.5	А

Thermal Characteristics

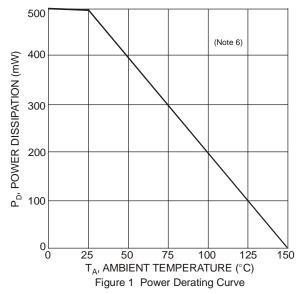
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 6)	P_{D}	500	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ heta JA}$	250	W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

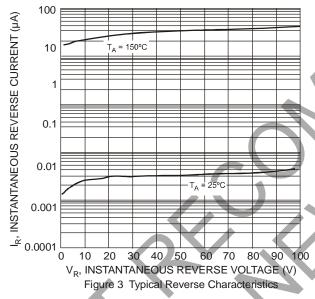
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

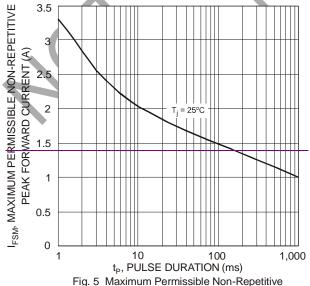
Characteristic	Symbol	Min	Max	Unit	Test Condition				
Reverse Breakdown Voltage (Note 5)	V _{BR(R)}	80		V	$I_R = 1\mu A$				
		_ `	0.715		$I_F = 1.0 \text{mA}$				
	VF		0.72		$I_F = 5.0 \text{mA}$				
Forward Voltage		_	0.855		$I_F = 10mA$				
Forward voitage	V	_	0.90	V	$I_F = 50 \text{mA}$				
		_	1.0		$I_F = 100mA$				
		_	1.25		$I_F = 150 \text{mA}$				
			25	nA	$V_R = 20V$				
							30	nA	$V_R = 25V$
Leakage Current (Note 5)	I_R	_	100	nA	$V_R = 80V$				
			30	μΑ	$V_R = 25V, T_J = +150$ °C				
			50	μΑ	$V_R = 75V, T_J = +150$ °C				
Total Capacitance	C _T	_	2.3	pF	$V_R = 0$, $f = 1.0MHz$				
Dovers Passiani Timo			4.0		$I_F = I_R = 10 \text{mA},$				
Reverse Recovery Time	t _{rr}	_	4.0	ns	$I_{rr} = 0.1 \text{ x } I_{R}, R_{L} = 100\Omega$				

^{5.} Short duration pulse test used to minimize self-heating effect.
6. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

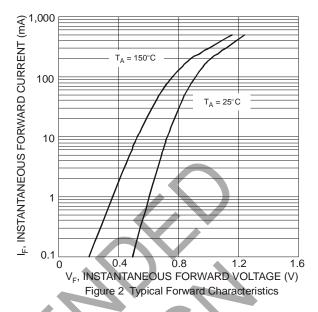


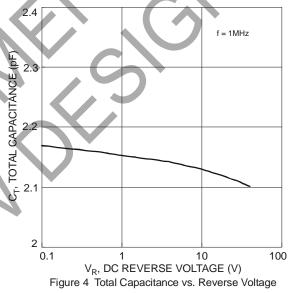


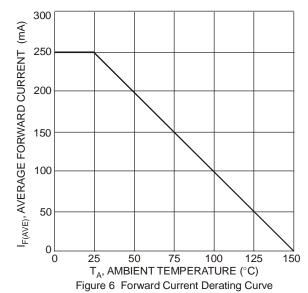




Peak Forward Current as a Function of Pulse Duration



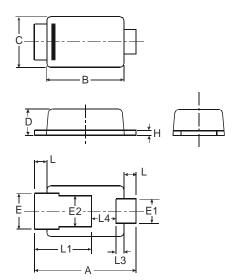






Package Outline Dimensions

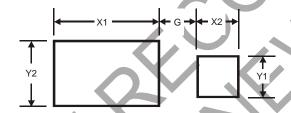
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



POWERDI [®] 323						
Dim	Min	Max	Тур			
Α	2.40	2.60	2.50			
В	1.85	1.95	1.90			
C	1.20	1.30	1.25			
D	0.60	0.70	0.65			
Е	0.78	0.98	0.88			
E1	0.50	0.70	0.60			
E2	0.60	1.00	0.80			
H	0.08	0.18	0.13			
/ 4	0.20	0.40	0.30			
L1	_	_	1.40			
L3	_	_	0.20			
L4	0.40	0.80	0.60			
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	0.5
X1	2.0
X2	0.8
Y1	0.8
Y2	1.1

NOT RECOMMENDED FOR NEW DESIGN USE 1N4448WSF-7



PD3SD2580

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